

UNITED STATES PATENT AND TRADEMARK OFFICE

BEFORE THE PATENT TRIAL AND APPEAL BOARD

SAMSUNG ELECTRONICS CO., LTD., AND SAMSUNG
ELECTRONICS AMERICA, INC.,
Petitioner,

v.

INVENSAS BONDING TECHNOLOGIES, INC.,
Patent Owner.

Case IPR2018-01267
Patent 6,825,554

Mailed: February 6, 2019

NOTICE OF REFUND

Petitioner's request for a refund of certain post-institution fees paid on June 15, 2018 in the above proceeding is hereby granted. The amount of \$15,000 has been refunded to Petitioner's deposit account.

The parties are reminded that unless otherwise permitted by 37 C.F.R. § 42.6(b)(2), all filings in this proceeding must be made electronically in the Patent Trial and Appeal Board End to End (PTAB E2E), accessible from the Board Web site at <http://www.uspto.gov/PTAB>.

If there are any questions pertaining to this notice, please contact the Patent Trial and Appeal Board at 571-272-7822.

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